
The 5th International Congress on Laser Advanced Materials Processing

LAMP2009

<http://www.lamp2009.org>

June 29 – July 2, 2009

Kobe Convention Center, Kobe, Japan

11-1 Minatojima-nakamachi, Chuo-ku, Kobe, 650-0046, Japan

Advertisement and Sponsorship Opportunities

Welcome to join us at LAMP2009, one of the 30th anniversary events of JLPS! The International Congress on Laser Advanced Materials Processing (LAMP) deals with science and technology of advanced laser materials processing covering precision microfabrication and high power laser processing. Basically LAMP is held every four years, and the former LAMPs have won the good reputation and popularity as the one of the most excellent international meetings in the world. LAMP2009 is held during June 29 – July 2, 2009, in Kobe, which is known as a city having a unique style with the exotic atmosphere in Japan, and flourished as the international port since old days, approx. 8th century. LAMP2009 consists of International Symposia on Laser Precision Microfabrication (LPM) and High Power Laser Processing (HPL) and covers hardware as well as software for fundamental research and industrial applications in both micro and macro processing. LAMP2009 is planned as a four-day event with a plenary session, oral and poster sessions, special sessions dealing with topical issues, and the exhibition with inviting most important world authorities in this field. The aim of this congress is to provide a forum for discussion of fundamental aspects of laser-matter interaction, the state-of-the-art of laser materials processing, and topics for the next generation with fundamental scientists, end users and laser manufacturers. We expect that LAMP2009 would play an important role not only for understanding fundamental knowledge of laser materials processing but also forecasting future technologies to be developed and the future laser market.

We would like to encourage you to become LAMP2009 event sponsor! Please select your sponsorship categories: Advertisements for Abstract Booklets, Gold, Silver or Bronze Sponsorships. For the details, please refer to the following pages. Thank you for your attention in advance.

Chair, LAMP2009
Prof. Dr. Isamu Miyamoto

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Price	¥70,000- per order; half size of A4 sized paper [Equivalent to A5 sized paper; Ad orientation with longer horizontal size than vertical]
Special Arrangements	① Per 2 orders from one company: One full-registration fee will be waived. Note: Banquet and Online Proceedings are not included in this waiver. If you wish to attend banquet, please order LAMP2009 office additionally. ② After the congress, we will send you the participants list. Note: The participants list includes the information of the participants who have consented the disclosure of their personal information.
Submission of Ad Materials	Please create your advertisement(s) complying with the guidelines mentioned below, and submit your electric file(s) to us by business mail no later than the due date.
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	GOLD Sponsorship---SOLD-OUT
Items	4 kinds; Plenary Session Sponsor, Poster Session Sponsor, Banquet Sponsor, and Congress Bag Sponsor
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Price	¥200,000- per order
Special Arrangements	① Per one order, one full-registration fee will be waived. Note: Banquet and Online Proceedings are not included in this waiver. If you wish to attend banquet, please order LAMP2009 office additionally. ② Per 2 orders, the sponsorship name will be raised up to PLATINUM. ③ After the congress, we will send you the participants list. Note: The participants list includes the information of the participants who have consented the disclosure of their personal information.
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How to Apply	Please fill out the final page of this file, and fax or e-mail back to us.
<Guidelines for Advertisements Specifications> Size: One A4 sized paper (Height 297mm x Width 210mm) Margins for regular order :Top/Bottom: Over 20mm, Right/Left : Over 15mm Color: Black & White Language: English is preferable. File: Fully completed clear file, please. Do not divide texts and figures separately. File should be possible to open with PDF, Photo Shop 6.0, or Adobe Illustrator 10.0. Submission : Please send the electric file and one print-out (hardcopy) to the following sending address by business mail. LAMP2009 Office (Attention: Ms. Hiromi Teraoka) c/o Katayama Lab., Joining and Welding Research Institute, Osaka University TEL/FAX: +81-6-6879-8642, E-mail: teraoka@jlps.gr.jp <Submission Due Date> Friday, April 24, 2009	

	SILVER Sponsorship ---SOLD-OUT
Items	2 kinds; Coffee Break, DAY-1 & DAY-2 or DAY-3 & DAY-4 combination
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Price	¥150,000- per order
Special Arrangements	① Per 2 orders from one company, one full-registration fee will be waived. Note: Banquet and Online Proceedings are not included in this waiver. If you wish to attend banquet, please order LAMP2009 office additionally. ② Per 2 orders, the sponsorship name will be raised up to PLATINUM. ③ After the congress, we will send you the participants list. Note: The participants list includes the information of the participants who have consented the disclosure of their personal information.
Submission of Ad Materials	Please create your advertisement(s) complying with the guidelines mentioned below, and submit your electric file(s) to us by business mail no later than the due date.
Submission of Company Logo	Please submit us both color and black & white versions of your company logo via e-mail.
How to Apply	Please fill out the final page of this file, and fax or e-mail back to us.
<Guidelines for Advertisements Specifications> Size: Half size of A4 sized paper (Height 148mm x Width 210mm) [Equivalent to A5 sized paper; Ad orientation with longer horizontal size than vertical] For 2 orders from one company, you can make one A4 sized ad instead of 2 ads at the half size of A4 sized paper. Margins for regular order :Top/Bottom/Right/Left : Over 15mm Margins for A4 sized ad: Top/Bottom: Over 20mm, Right/Left: over 15mm Color: Black & White Language: English is preferable. File: Fully completed clear file, please. Do not divide texts and figures separately. File should be possible to open with PDF, Photo Shop 6.0, or Adobe Illustrator 10.0. Submission : Please send the electric file and one print-out (hardcopy) to the following sending address by business mail. LAMP2009 Office (Attention: Ms. Hiromi Teraoka) c/o Katayama Lab., Joining and Welding Research Institute, Osaka University TEL/FAX: +81-6-6879-8642, E-mail: teraoka@jlps.gr.jp <Submission Due Date> Friday, April 24, 2009	

	BRONZE Sponsorship
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Price	¥40,000- per order
Special Arrangements	① Per 4 orders from one company, one full-registration fee will be waived. Note: Banquet and Online Proceedings are not included in this waiver. If you wish to attend banquet, please order LAMP2009 office additionally. ② After the congress, we will send you the participants list. Note: The participants list includes the information of the participants who have consented the disclosure of their personal information.
Submission of Company Logo	Please submit us both color and black & white versions of your company logo via e-mail.
How to Apply	Please fill out the final page of this file, and fax or e-mail back to us.
Submit your company logo to: LAMP2009 Office (Attention: Ms. Hiromi Teraoka) E-mail: teraoka@jlps.gr.jp	

Payment Due Date of Bank Wire Transfer: **Monday, June 15, 2009**

[Bank Information for Wire-Transfer to JLPS]

Bank: Sumitomo Mitsui Banking Corporation

Branch: Toyonaka Branch

SWIFT code: SMBCJPJTOSA

Bank code: #154

Account name: " LPM LAMP Shikin Kanrisha Katayama Seiji "

Account type: Regular (Futsu)

Account Number: 6809874

Bank address: 1-9-5 Honmachi, Toyonaka, Osaka, 560-0021, Japan

Bank phone #: +81-6-6854-2243

Note: When you make the wire transaction, please make sure to add ¥2500 bank handling charge additionally.

How to apply :

Please fill out the order form shown on the next page, and fax or e-mail back to us.

Special Information on Exhibition :

We are planning to hold the collocated exhibition named "Industrial Laser Japan 2009" to be arranged by e. x. press at Kobe Convention Center. If you are interested in the Exhibition, please directly contact Mr. Masaki Mori, Managing Director, e.x. press. E-mail: masaki.mori@ex-press.jp

To: LAMP2009 Office, FAX: +81-6-6879-8642, E-mail: teraoka@jlps.gr.jp

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Date:	(Month/Date/Year)		Application Number (For LAMP Office Use)
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Branch Name			
Department (Your title)			
Person in Charge	(First name, Middle Name(if applicable), LAST NAME)		
Your Address	Street Address		
	City		
	Prefecture/State		
	TEL	TEL: Contry Code + - Area Code – TEL Number	
	FAX	FAX: Contry Code + - Area Code – TEL Number	
	E-mail	(Clearly write under-bar, hyphen, etc.)	
Partnership	Items		Number
	Advertisement (@ ¥70,000)		Price
	GOLD Sponsorship (@ ¥200,000) ☆ <i>Please circle what you would like to order:</i> Plenary, Poster, Banquet, Congress Bag		SOLD-OUT SOLD-OUT
	SILVER Sponsorship (@ ¥150,000) ☆ <i>Please circle what you would like to order:</i> Coffee Break: DAY-1 & 2, or DAY-3 & 4		SOLD-OUT SOLD-OUT
	BRONZE Sponsorship (@ ¥40,000)		¥
	SUB-TOTAL		¥
	Bank Handling Charge		¥ 2500-
	TOTAL		¥
Link to your Company Website	1. Yes, please. 2. No, thank you.		
	Your URL	http://	
Advertisement Submission will be on		(Month/Date/Year)	
Payment to be on		(Month/Date/Year)	